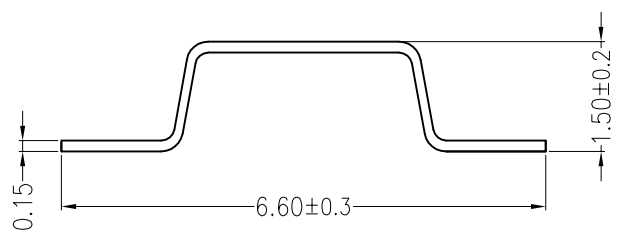
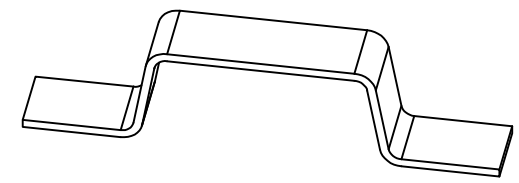
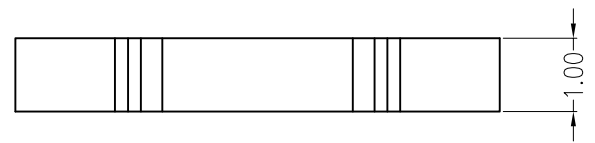


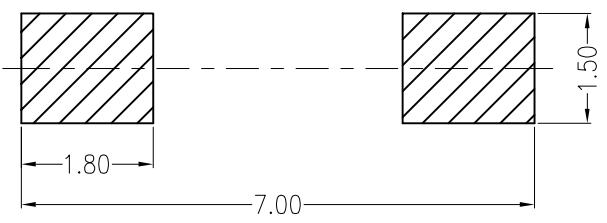
REV	ECN No.	DESCRIPTION	DESIGN	DATE
A0		Release	吴丹平	2017.03.23



ORDER INFORMATION:

L073B-01-000A1-R

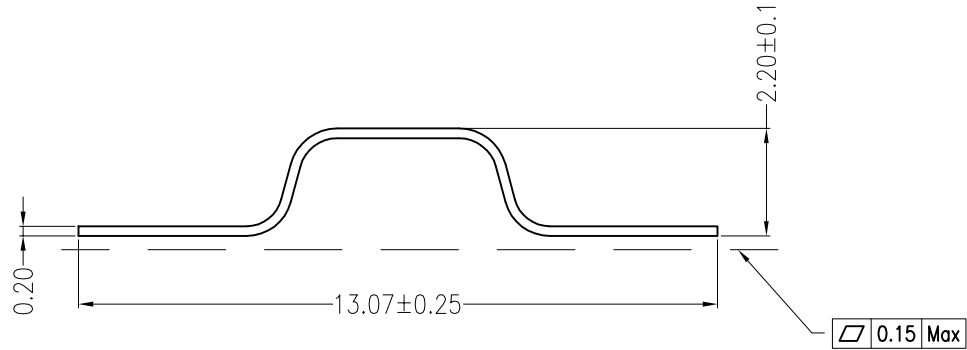
PART No.:	L073B-01-000A1-R	PACKAGING:	R=REEL
No.OF CIRCUITS:	01	Metal code:	1=PhosphorBronze
PLASTIC MATERIAL:	000=No plastic parts	PLATING:	A=Sn



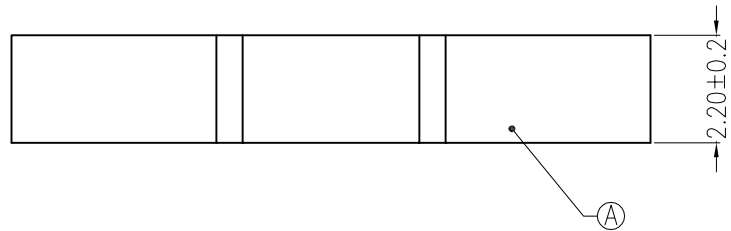
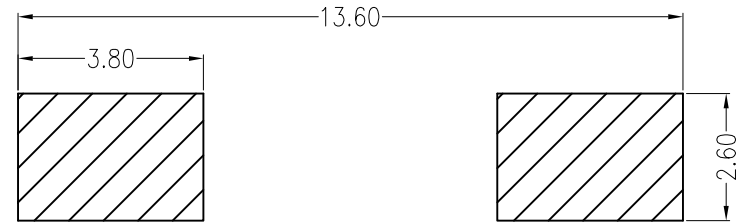
Board Layout

C				
B				
A	CONTACT	1 PCS	PhosphorBronze	Sn-plated
ITEM	COMPONENT	Q'TY	MATERIAL	FINISH

广东科斯达电子科技有限公司 GUANG DONG KE SI DA ELECTRONIC TECHNOLOGY CO., LTD.			TITLE: --
X.±0.5	X.±5'	USE:	PART NO.:
.X±0.3	.X±2'	CUSTOMEP	L073B-01-000A1-R
.XX±0.25	.XX±1'	APPD: 邵敬和	DWG NO.:
--	--	CHKD: 田峰	GCCP-1023
⊕	◁	UNITS: mm	SCALE
		DR: 吴丹平	1 : 1
			SHEET
			1 / 1



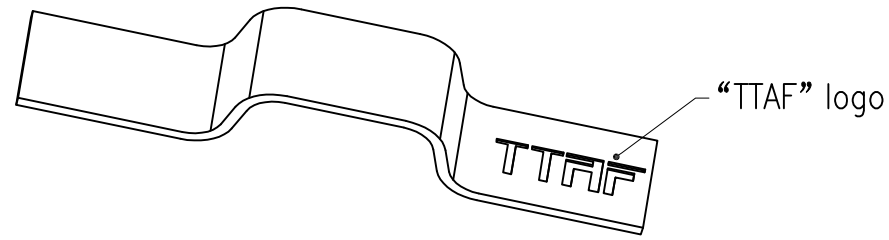
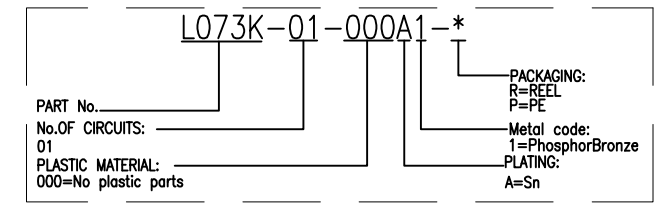
REV	ECN No.	DESCRIPTION	DESIGN	DATE
A	-	Release	蒋建银	2018.01.10



主要技术参数 Main Specifications

- 线 数 (Poles): 01
- 接触电阻 (Contact resistance): ≤30mΩ
- 绝缘电阻 (Insulation resistance):
- 额定电压 (Rated voltage): 250V AC DC
- 额定电流 (Rated current): 2.0A AC DC
- 耐 电压 (Withstand Voltage):
- 温度范围 (Temperature Range): -40°C ~ +125°C

ORDER INFORMATION:



C				
B				
A	CONTACT	1 PCS	PhosphorBronze	Sn-plated
ITEM	COMPONENT	Q'TY	MATERIAL	FINISH
广东科斯达电子科技有限公司 GUANG DONG KE SI DA ELECTRONIC TECHNOLOGY CO., LTD.		TITLE: L073K		180°wafer smt type
.X±0.35	X.±	USE:	PART NO.:	
.XX±0.25	.X±	CUSTOMER	L073K-01-000A1-R	
.XXX±0.15	.XX±	APPD: 邵敬和	DWG NO.:	
--	--	CHKD: 田 峰	GCCP-0430	
	UNITS: mm	DR: 蒋建银	SCALE	SHEET
			1 : 1	1 / 1